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**nTact to Exhibit its Extrusion Coating Technology at the  
Printed Electronics Conference in Santa Clara, CA**  
*nTact Established as Significant Supplier for R&D and Turnkey Production  
Equipment Solutions for Printed and Organic Electronics Applications*

DALLAS, Texas – Nov. 14, 2011 – nTact (formerly known as FAS) is pleased to announce that it will be exhibiting at the Printed Electronics USA 2011 and Photovoltaics USA Conference in Santa Clara, CA from November 30 through December 1, 2011. During the conference, they will be featuring their nDeavor Series extrusion coating system for full production, solution-based processing, as well as their nRad system, a small footprint, low cost slot-die coating system, engineered for use in R&D and pre-production environments. To learn more about nTact’s extrusion coating technology, please visit: [www.nTact.com](http://www.nTact.com)

In addition, nTact will be announcing its offering of Atmospheric Pressure Plasma (“AP Plasma”) systems, a new line of products recently added to their portfolio. AP Plasma treatment is used for removing organic contamination from the substrate surface, as well as adjusting the surface energy of the substrate to “activate” the surface prior to coating. AP Plasma is used for similar applications as traditional UV Ozone treatments, but has demonstrated superior performance characteristics in terms of effectiveness and cost of ownership, and has become widely used in the LCD industry to provide enhanced coating performance. AP Plasma systems are offered as a standalone process module or integrated into nTact’s coating equipment, and are available to address a wide range of substrate sizes.

nTact is emerging as an important supplier for turnkey and custom equipment solutions in the organic and printed electronics and photovoltaic (PV) markets. The company’s products have recently been adopted for applications in OLED Lighting, Touch Screen, Flexible Displays, and Solution-Processed PV.

“The Plastic Electronics Conference presents a great opportunity for nTact, as it serves the markets and applications that are ideally suited for our technology,” said David Torres, CEO of nTact. Mr. Torres went on to say: “The focus of nTact over the last several years has been in technologies for printed and organic electronics applications. We have invested considerable resources in optimizing our technologies for these markets. Our technology has produced excellent results with a variety of these specialized materials and substrates, and manufacturers in the PV, OLED and various other emerging markets are really starting to take notice.”

nTact will be exhibiting at Booth F102 at the Santa Clara Convention Center Hall A in Santa Clara, CA. The Printed Electronics USA 2011 and Photovoltaics USA Conference will feature speakers from academia and industry discussing technical breakthroughs and emerging technologies: <http://www.idtechex.com/printed-electronics-usa-11/>

## About nTact:

nTact, a company formerly known as FAS, is engaged in the design, development, manufacture and integration of advanced coating systems and integrated process solutions for the display, microelectronics, alternative energy, and related industries. The company is a pioneer in the development of coating equipment for a wide range of applications, and is the inventor of the extrusion or “spinless” coating, a slot die based technology that has become the standard deposition method for the flat panel display industry. nTact has further developed its proprietary deposition technology to meet the needs of a variety of applications in emerging markets, including the deposition of submicron layers of organic materials for OLED displays and lighting applications, dielectric layers, suspensions, and active photovoltaic layers. For more information, visit [www.nTact.com](http://www.nTact.com)

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